



| Docket No. | • | |
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DECLARATION AND POWER OF ATTORNEY

| As a below named invento | or, I hereby declare that: | | | | | |
|--|--|--|---|---|--|--|
| My residence, post office and citizenship are as stated below next to my name, | | | | | | |
| names are listed below) of | first and sole inventor (if only one nam the subject matter claimed and for whi ISPLAY PANEL | e is listed below) or an o ch a patent is sought on | riginal, first and joint the invention entitled | inventor (if plural | | |
| the specification of which | | | | , | | |
| [] is attached hereto | [] was filed onamended on | as Application Serial (if applicable | No :) | and was | | |
| I hereby state that I have re by any amendment referre | viewed and understand the contents of ted to above. | he above identified specif | ication, including the c | claims, as amended | | |
| I acknowledge the duty to Code of Federal Regulatio | disclose information which is known t ns, Section 1.56(a). | o me to be material to pa | atentability in accorda | nce with Title 37, | | |
| application(s) for patent or | ority or provisional application benefit inventor's certificate, or provisional app nventor's certificate, or provisional app | lication(s) listed below as | nd have also identified | below any toreign | | |
| Prior Foreign Applicatio Number | n(s) or U.S. Provisional Application(s) Country Day/Month/Yes | s): Priority (ar Yes | Claimed <u>No</u> | | | |
| P01-2802 Repub | olic of Korea 18/01/200 | | | | | |
| as the subject matter of eac provided by the first paragr as defined in Title 37, Code | nder Title 35, United States Code, Section ch of the claims of this application is no raph of Title 35, United States Code, Sec to of Federal Regulations, Section 1.56(a) international filing date of this application | ot disclosed in the prior l tion 112, I acknowledge t which occurred between | United States applicati the duty to disclose ma | on in the manner terial information | | |
| Prior U. S. Application(s Serial No. |): Filing Date | Status: Pat | ented, Pending, Abar | ndoned | | |
| | | | | | | |
| I hereby declare that all stabelief are believed to be true | ntements made herein of my own know e; and further that these statements wer | rledge are true and that a e made with the knowle | ull statements made on dge that willful false st | information and atements and the | | |

like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that

such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Post Office Address:





I hereby appoint the following attorney(s) and/or agent(s):Daniel Y.J. Kim, Registration No. 36,186 and Mark L. Fleshner. Registration No. 34,596; Carl R. Wesolowski, Registration No. 40,372, John C. Eisenhart, Registration No. 38,128, Rene A. Vazquez, Registration No. 36,647, all of

FLESHINER & KIM
P. O. Box 221200
Chantilly, Virginia 20153-1200

| with full power of substitution and revocation, to prosecute this application and to tran Office connected therewith, and all future correspondence should be addressed to the | em. |
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| · · · · · · · · · · · · · · · · · · · | *********** |
| Full name of sole or first inventor: KIM, Jae Sung | |
| Inventor's signature: KIM, Jae Sung | Date: Dec. 15, 200 |
| Residence: Seoul, Korea | |
| Citizenship: Republic of Korea | |
| Post Office Address: #20 Yoido-dong, Youngdungpo-gu, Seo | |
| ###################################### | ****************** |
| Full name of joint inventor(s): AHN, Young Joon | |
| Inventor's signature: Ahn Young Joon | Date: 12.28,2001 |
| Residence: Seoul, Korea | |
| Citizenship: Republic of Korea | |
| Post Office Address: #20 Yoido-dong, Youngdungpo-gu, Seoul | |
| ************************************* | ····································· |
| Full name of joint inventor(s): | |
| Inventor's signature: | Date: |
| Residence: | |
| Citizenship: | |
| Post Office Address: | |
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| Inventor's signature: | Date: |
| Residence: | |
| Citizenship: | |
| Post Office Address: | |
| *************************************** | ************** |
| Full name of joint inventor(s): | |
| Inventor's signature: | Date: |
| Residence: | |
| Citizenship: | . , |
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